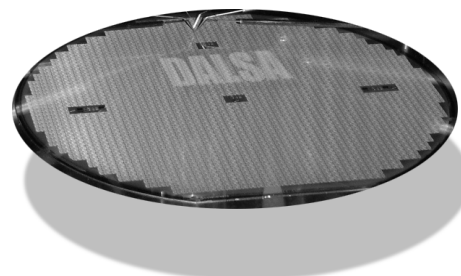


C08C 0.8 μ m 5V CMOS Process

DALSA
Semiconductor's
proven ability to
transfer and
develop
customized
processes is
unmatched in
the industry

C08C Overview

- 0.8 μ m 5V CMOS process, compatible with most 0.8 μ m CMOS processes in the industry.
- Twin-tub, P or N type epi or bulk substrates
- Single or double poly
- Two or three layer metal process



Features

- Propagation delay: $T_{pd} = 200\text{ps}$
- High value (10k Ω /sq.) and low TCR poly resistor options
- Fully transportable to C08E and C08G high voltage processes
- ProToDuction™ option for low-cost prototyping
- BSIM3v3.22 models available in Hspice and Spectre
- Comprehensive mixed signal Cadence Foundry Design Kit (FDK) available

Mixed Signal Capabilities

- 5V double poly capacitor (1.05fF/ μm^2)
- High value poly resistor option (10k Ω /sq)
- 5V 0.8 μ m cmos
- Polysilicon fuses
- Digital gate count 1.8K gates/mm²

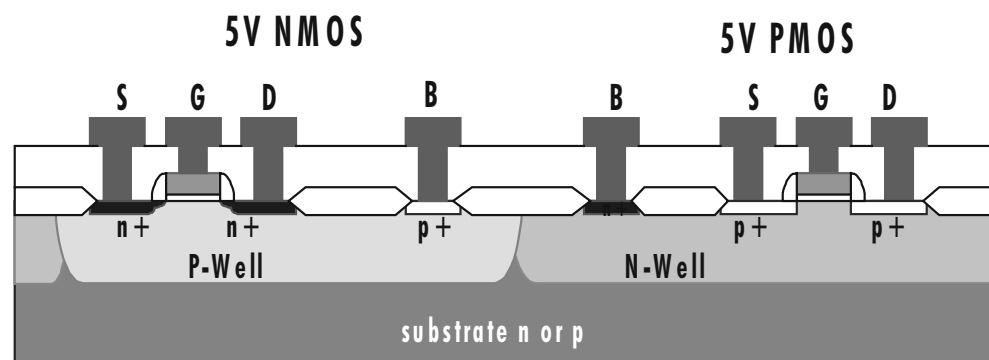
Applications

- All 5V digital, analog or mixed signal circuits

Layout Rules

Layer	Width (μm)	Space (μm)
Poly 1	0.8	0.9
Poly2	1.0	1.2
Contact	0.9x0.9	0.8
Metal 1	1.1	1.0
Via	1.0x1.0	1.0x1.0
Metal 2	1.2	1.1
Via 2	2.0x2.0	2.0
Metal 3	3.0	2.4

Simplified Cross-Section of 5V CMOS



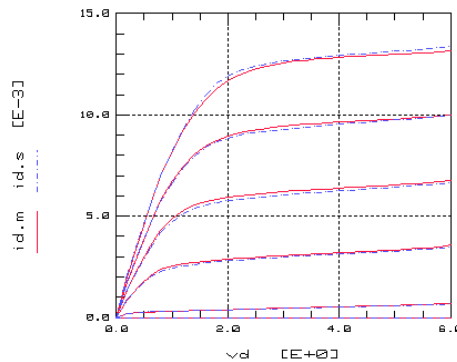
26-Sep-02
03-70-00146-00
www.dalsasemi.com

Electrical Parameters of Representative Transistors

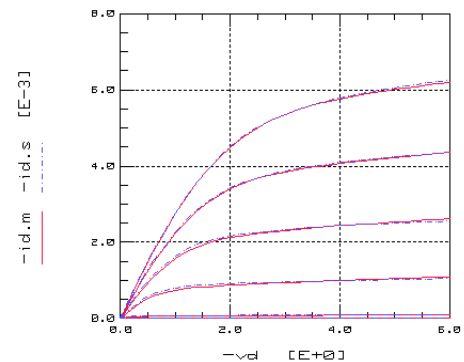
Parameter	5V NMOS	5V PMOS
W x L (μ m)	50 x 0.8	50 x 0.8
VT (V)	0.65	-0.65
Ids (mA)	19	9
Bvdss (V)	12	12
Isub (μ A/ μ m)	0.85	-
RON (Ω)	86	256

Resistor Type	Sheet Res Ω /sq
Poly 1	50 \pm 25
Poly 2	37 \pm 15
Low TCR	325 \pm 100
HiRes	10K \pm 3K

**Example NMOS Output Curve
(L=0.8 μ m, W=32 μ m)**



**Example PMOS Output Curve
(L=0.8 μ m, W=32 μ m)**



For More Information

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